



High power cycling capability  
Low on-state and switching losses  
Designed for traction and industrial applications

## Phase Control Thyristor Type T343-400-44

Mean on-state current	I <sub>TAV</sub>	400 A		
Repetitive peak off-state voltage	V <sub>DRM</sub>	3800 ÷ 4400 V		
Repetitive peak reverse voltage	V <sub>RRM</sub>			
Turn-off time	t <sub>q</sub>	500, 630, 800 µs		
V <sub>DRM</sub> , V <sub>RRM</sub> , V	3800	4000	4200	4400
Voltage code	38	40	42	44
T <sub>j</sub> , °C		-60 ÷ 125		

### MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions	
<b>ON-STATE</b>					
I <sub>TAV</sub>	Mean on-state current	A	400 455	T <sub>c</sub> =92 °C, Double side cooled T <sub>c</sub> =85 °C, Double side cooled 180° half-sine wave; 50 Hz	
I <sub>TRMS</sub>	RMS on-state current	A	628	T <sub>c</sub> =92 °C, Double side cooled 180° half-sine wave; 50 Hz	
I <sub>TSM</sub>	Surge on-state current	kA	6.5 7.5	T <sub>j</sub> =T <sub>j</sub> max T <sub>j</sub> =25 °C 180° half-sine wave; t <sub>p</sub> =10 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs	
			7.0 8.0	T <sub>j</sub> =T <sub>j</sub> max T <sub>j</sub> =25 °C 180° half-sine wave; t <sub>p</sub> =8.3 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs	
I <sup>2</sup> t	Safety factor	A <sup>2</sup> ·10 <sup>3</sup>	210 280	T <sub>j</sub> =T <sub>j</sub> max T <sub>j</sub> =25 °C 180° half-sine wave; t <sub>p</sub> =10 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs	
			200 260	T <sub>j</sub> =T <sub>j</sub> max T <sub>j</sub> =25 °C 180° half-sine wave; t <sub>p</sub> =8.3 ms; single pulse; V <sub>D</sub> =V <sub>R</sub> =0 V; Gate pulse: I <sub>G</sub> =2 A; t <sub>GP</sub> =50 µs; di <sub>G</sub> /dt≥1 A/µs	
<b>BLOCKING</b>					
V <sub>DRM</sub> , V <sub>RRM</sub>	Repetitive peak off-state and Repetitive peak reverse voltages	V	3800÷4400	T <sub>j min</sub> < T <sub>j</sub> <T <sub>j</sub> max; 180° half-sine wave; 50 Hz; Gate open	
V <sub>DSM</sub> , V <sub>RSM</sub>	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	3900÷4500	T <sub>j min</sub> < T <sub>j</sub> <T <sub>j</sub> max; 180° half-sine wave; single pulse; Gate open	
V <sub>D</sub> , V <sub>R</sub>	Direct off-state and Direct reverse voltages	V	0.6V <sub>DRM</sub> 0.6V <sub>RRM</sub>	T <sub>j</sub> =T <sub>j</sub> max; Gate open	

TRIGGERING				
$I_{FGM}$	Peak forward gate current	A	8	$T_j=T_{j\max}$
$V_{RGM}$	Peak reverse gate voltage	V	5	
$P_G$	Gate power dissipation	W	4	$T_j=T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ( $f=1$ Hz)	A/ $\mu$ s	500	$T_j=T_{j\max}$ ; $V_D=0.67V_{DRM}$ ; $I_{TM}=1250$ A; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 2$ A/ $\mu$ s
THERMAL				
$T_{stg}$	Storage temperature	°C	-60÷50	
$T_j$	Operating junction temperature	°C	-60÷125	
MECHANICAL				
F	Mounting force	kN	14.0÷16.0	
a	Acceleration	m/s <sup>2</sup>	50	Device clamped

## CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions
ON-STATE				
$V_{TM}$	Peak on-state voltage, max	V	2.25	$T_j=25$ °C; $I_{TM}=1256$ A
$V_{T(TO)}$	On-state threshold voltage, max	V	1.117	$T_j=T_{j\max}$ ;
$r_T$	On-state slope resistance, max	$m\Omega$	1.245	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$
$I_L$	Latching current, max	mA	1000	$T_j=25$ °C; $V_D=12$ V; Gate pulse: $I_G=2$ A; $t_{GP}=50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
$I_H$	Holding current, max	mA	300	$T_j=25$ °C; $V_D=12$ V; Gate open
BLOCKING				
$I_{DRM}$ , $I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	100	$T_j=T_{j\max}$ ; $V_D=V_{DRM}$ ; $V_R=V_{RRM}$
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ $\mu$ s	200, 320, 500, 1000, 1600, 2000, 2500	$T_j=T_{j\max}$ ; $V_D=0.67V_{DRM}$ ; Gate open
TRIGGERING				
$V_{GT}$	Gate trigger direct voltage, max	V	3.00 2.50 1.50	$T_j=T_{j\min}$ $T_j=25$ °C $T_j=T_{j\max}$
$I_{GT}$	Gate trigger direct current, max	mA	400 250 150	$T_j=T_{j\min}$ $T_j=25$ °C $T_j=T_{j\max}$
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.45	$T_j=T_{j\max}$ ;
$I_{GD}$	Gate non-trigger direct current, min	mA	55.00	$V_D=0.67V_{DRM}$ ; Direct gate current
SWITCHING				
$t_{gd}$	Delay time, max	$\mu$ s	3.20	$T_j=25$ °C; $V_D=1500$ V; $I_{TM}=I_{TAV}$ ; $di/dt=200$ A/ $\mu$ s;
$t_{gt}$	Turn-on time, max	$\mu$ s	15.00	Gate pulse: $I_G=2$ A; $V_G=20$ V; $t_{GP}=50$ $\mu$ s; $di_G/dt=2$ A/ $\mu$ s
$t_q$	Turn-off time <sup>2)</sup> , max	$\mu$ s	500, 630, 800	$dv_D/dt=50$ V/ $\mu$ s; $T_j=T_{j\max}$ ; $I_{TM}=I_{TAV}$ ; $di_R/dt=-10$ A/ $\mu$ s; $V_R=100$ V; $V_D=0.67V_{DRM}$
$Q_{rr}$	Total recovered charge, max	$\mu$ C	1760	$T_j=T_{j\max}$ ; $I_{TM}=400$ A;
$t_{rr}$	Reverse recovery time, max	$\mu$ s	40	$di_R/dt=-5$ A/ $\mu$ s;
$I_{rrM}$	Peak reverse recovery current, max	A	88	$V_R=100$ V

THERMAL						
$R_{thjc}$	Thermal resistance, junction to case, max			0.0350	Direct current	Double side cooled
$R_{thjc-A}$				0.0770		Anode side cooled
$R_{thjc-K}$				0.0630		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max		°C/W	0.0060	Direct current	

### MECHANICAL

W	Weight, max	g	280			
$D_s$	Surface creepage distance	mm (inch)	27.60 (1.087)			
$D_a$	Air strike distance	mm (inch)	16.00 (0.630)			

### PART NUMBERING GUIDE

T	343	400	44	A2	B2	N
1	2	3	4	5	6	7

1. Phase Control Thyristor
2. Design version
3. Mean on-state current, A
4. Voltage code
5. Critical rate of rise of off-state voltage, V/ $\mu$ s
6. Turn-off time ( $dv_D/dt=50$  V/ $\mu$ s)
7. Ambient conditions: N – normal; T – tropical

### NOTES

<sup>1)</sup> Critical rate of rise of off-state voltage

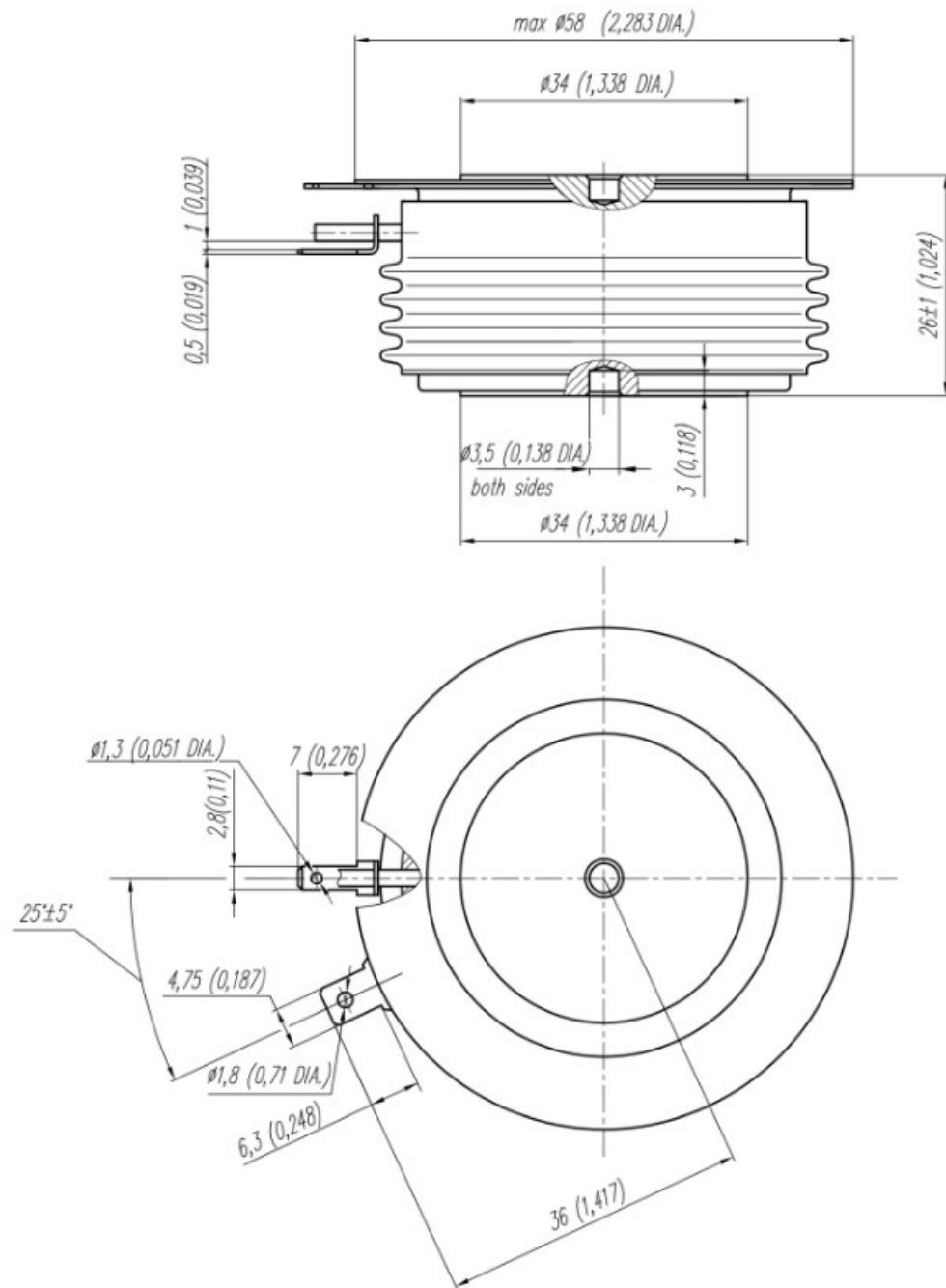
Symbol of Group $(dv_O/dt)_{crit}$ , V/ $\mu$ s	P2	K2	E2	A2	T1	P1	M1
200	320	500	1000	1600	2000	2500	

<sup>2)</sup> Turn-off time ( $dv_D/dt=50$  V/ $\mu$ s)

Symbol of Group $t_{q, \mu s}$	E2	C2	B2
500	630	800	

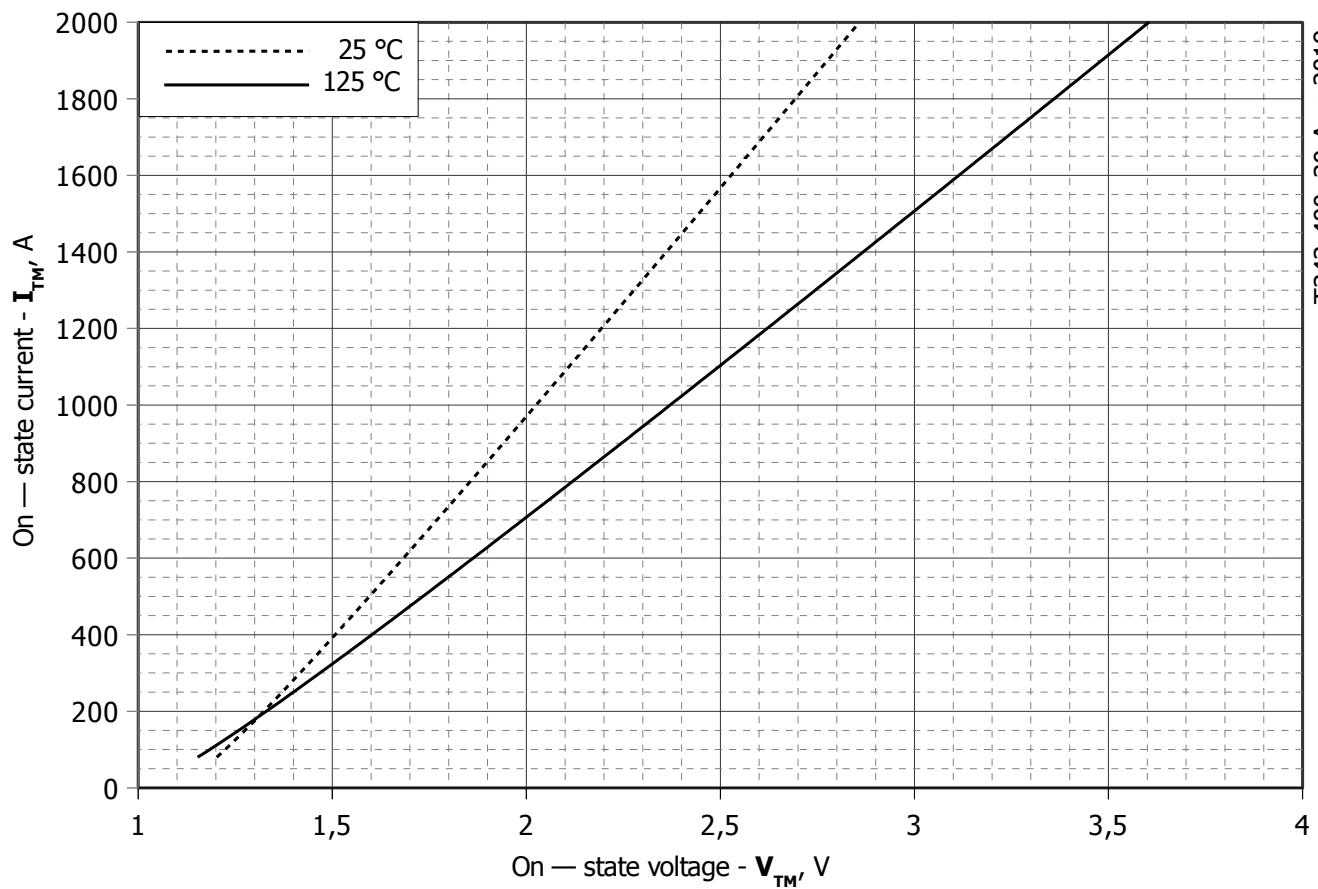
## OVERALL DIMENSIONS

Package type: T.C3



All dimensions in millimeters (inches)

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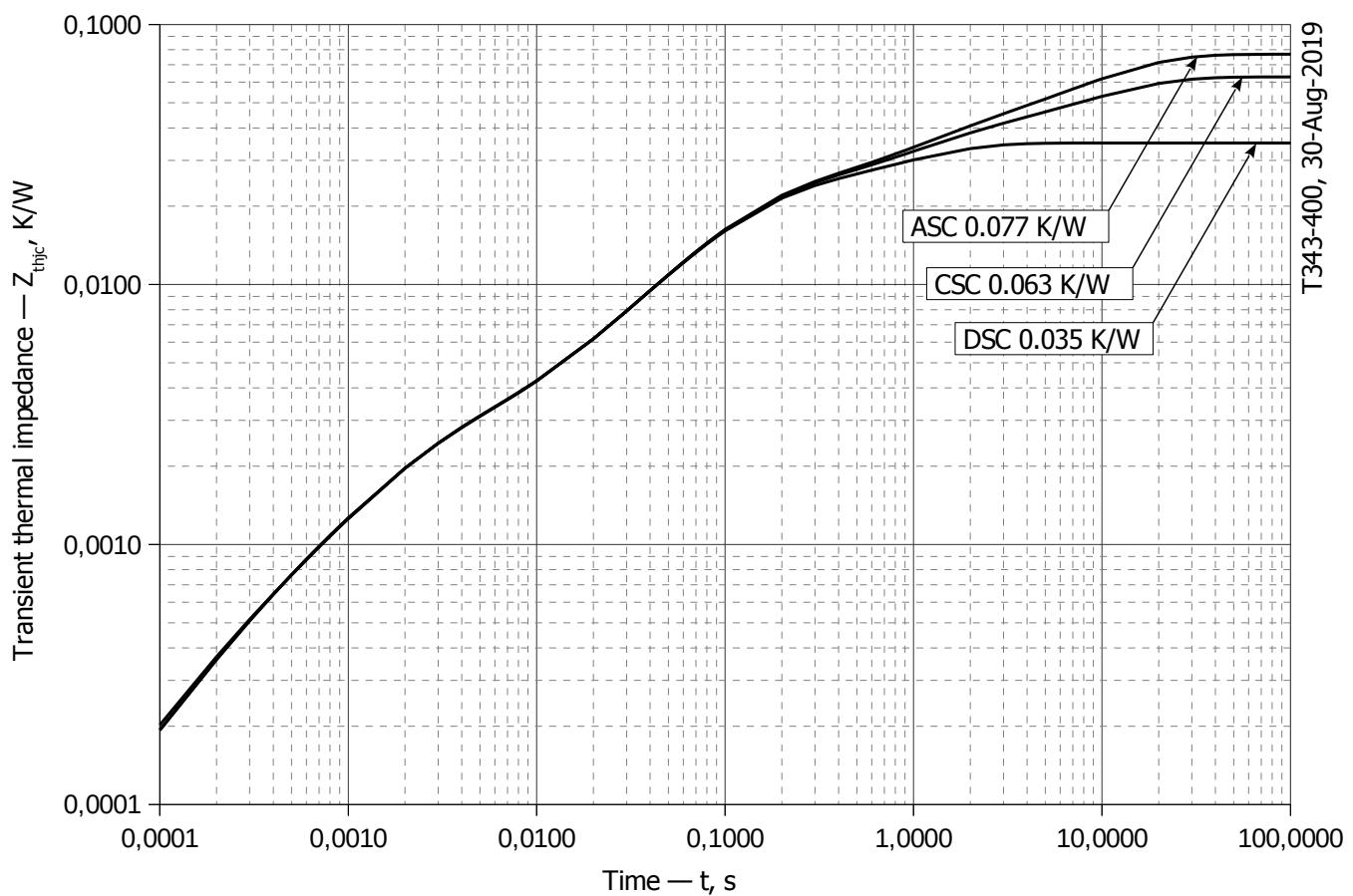
**Fig 1 – On-state characteristics of Limit device**

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	T <sub>j</sub> = 25°C	T <sub>j</sub> = T <sub>j max</sub>
<b>A</b>	1.05900000	0.97757680
<b>B</b>	0.00078162	0.00114000
<b>C</b>	0.01165600	0.00518530
<b>D</b>	0.00329660	0.00687000

**On-state characteristic model (see Fig. 1)**

**Fig 2 – Transient thermal impedance  $Z_{thjc}$  vs. time  $t$** 

Analytical function for Transient thermal impedance junction to case  $Z_{thjc}$  for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left( 1 - e^{-\frac{t}{\tau_i}} \right)$$

Where  $i = 1$  to  $n$ ,  $n$  is the number of terms in the series.

$t$  = Duration of heating pulse in seconds.

$Z_{thjc}$  = Thermal resistance at time  $t$ .

$R_i$  = Amplitude of  $p_{th}$  term.

$\tau_i$  = Time constant of  $r_{th}$  term.

DC Double side cooled

i	1	2	3	4	5	6
$R_i$ , K/W	2.007e-005	0.01412	0.01797	0.0007764	0.00193	0.0001844
$\tau_i$ , s	4.957	0.9362	0.09335	0.04227	0.001702	0.0002492

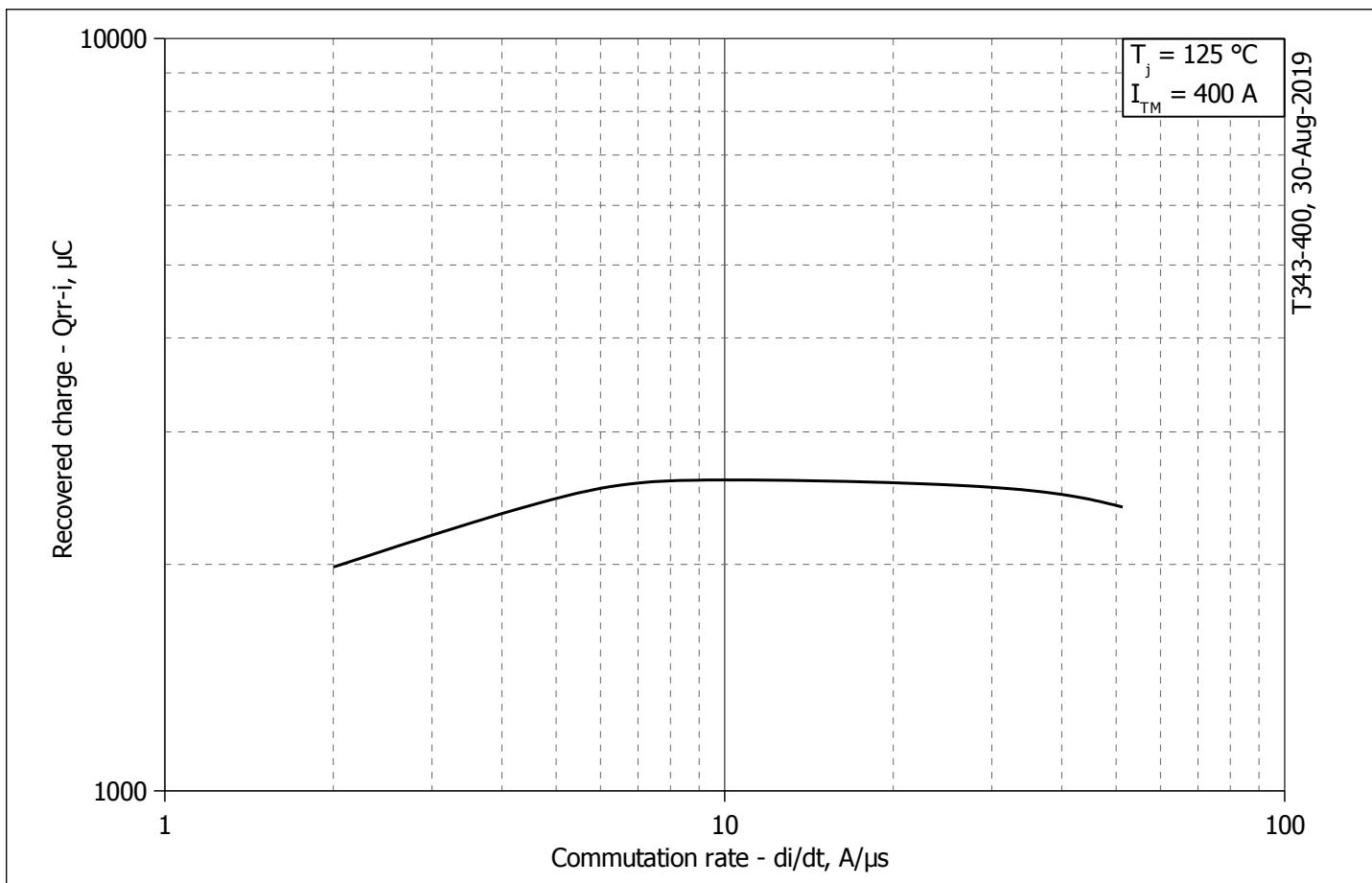
DC Anode side cooled

i	1	2	3	4	5	6
$R_i$ , K/W	0.04173	0.01173	0.01847	0.001981	0.0001722	0.002719
$\tau_i$ , s	9.751	1.085	0.09044	0.00175	0.0001916	0.791

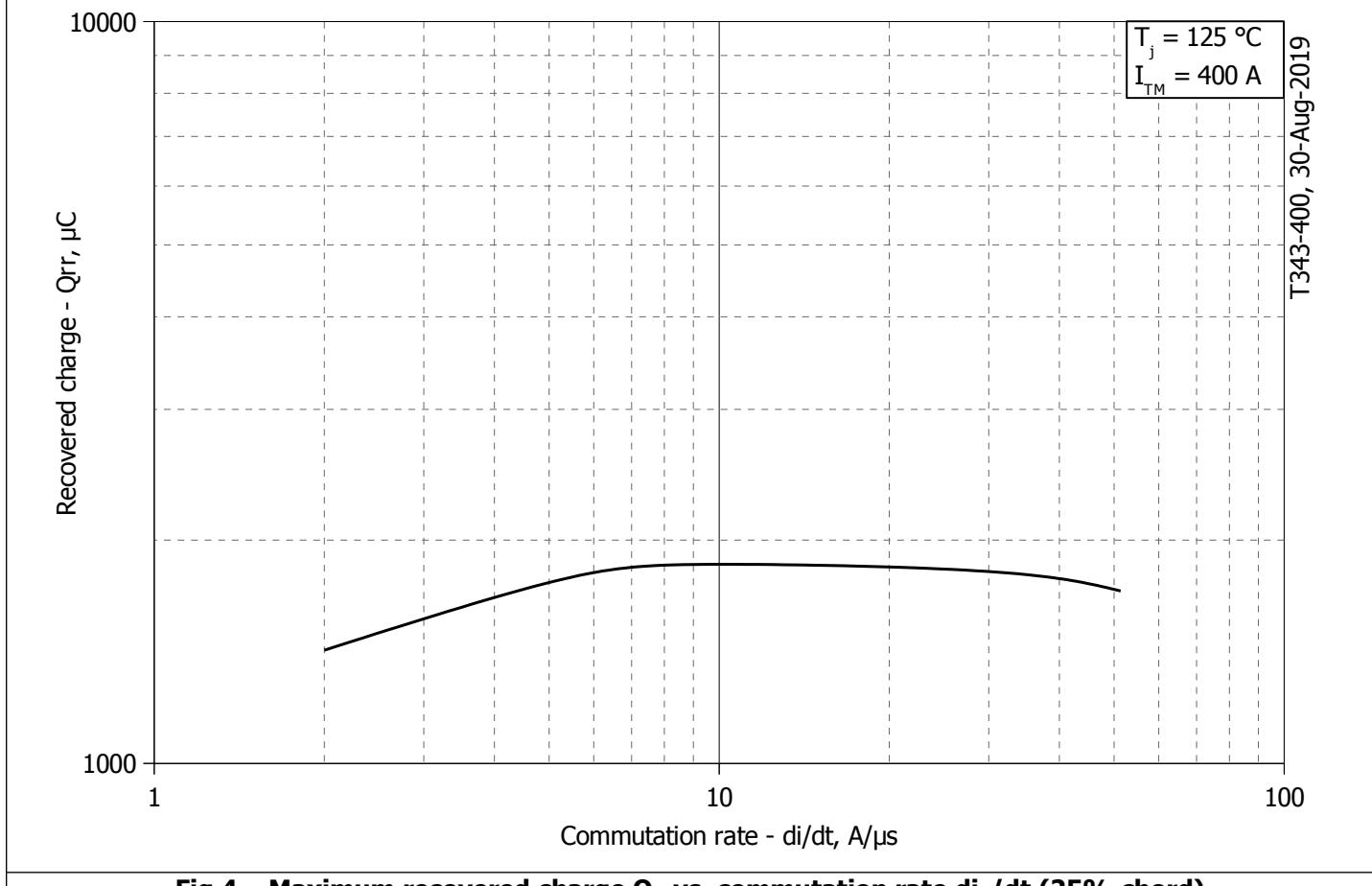
DC Cathode side cooled

i	1	2	3	4	5	6
$R_i$ , K/W	0.02781	0.0007698	0.01797	0.001931	0.000209	0.01416
$\tau_i$ , s	9.752	0.186	0.08881	0.001757	0.0002747	1.004

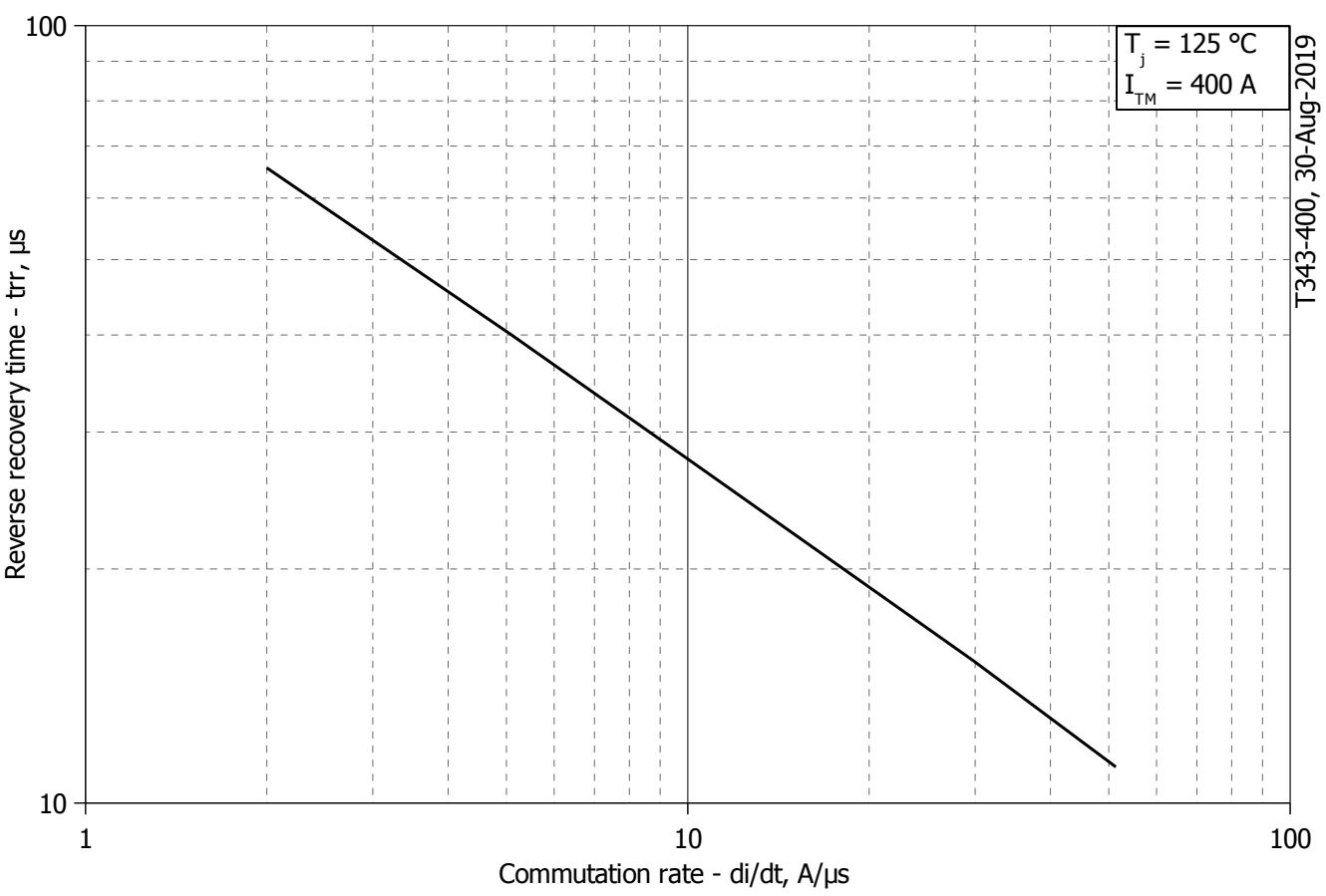
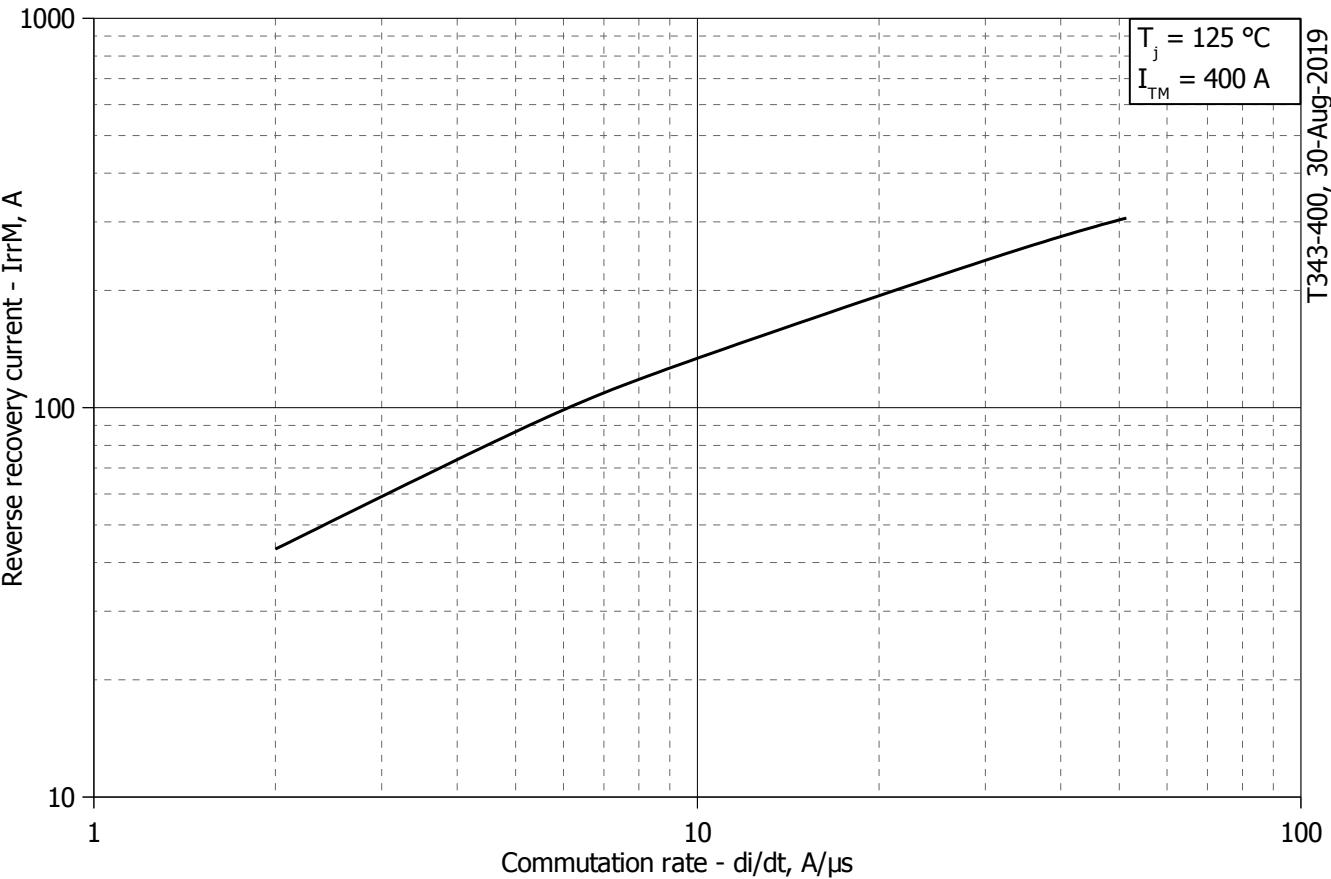
**Transient thermal impedance junction to case  $Z_{thjc}$  model (see Fig. 2)**

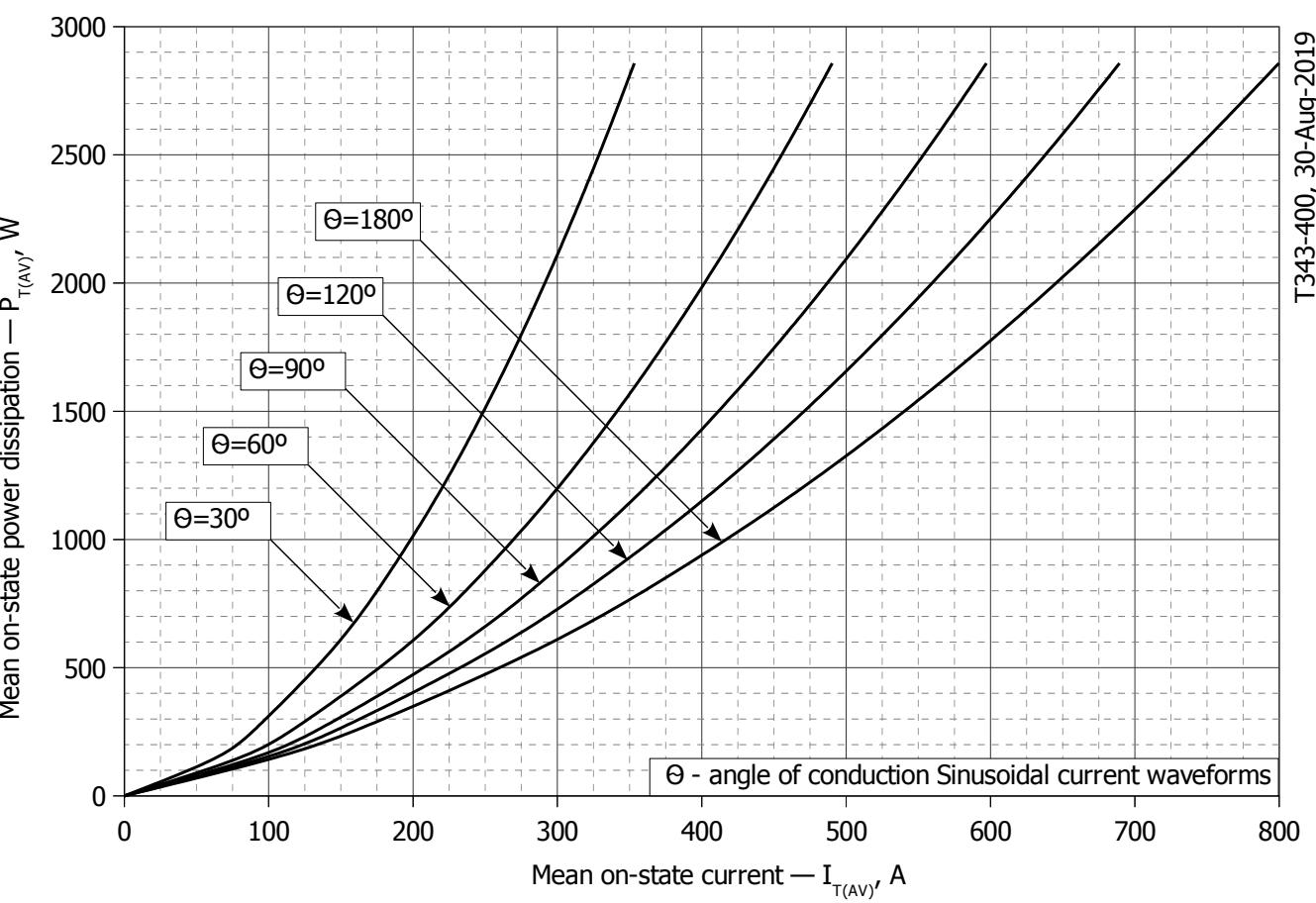


**Fig 3 – Maximum recovered charge  $Q_{rr-i}$  (integral) vs. commutation rate  $d_i R/dt$**

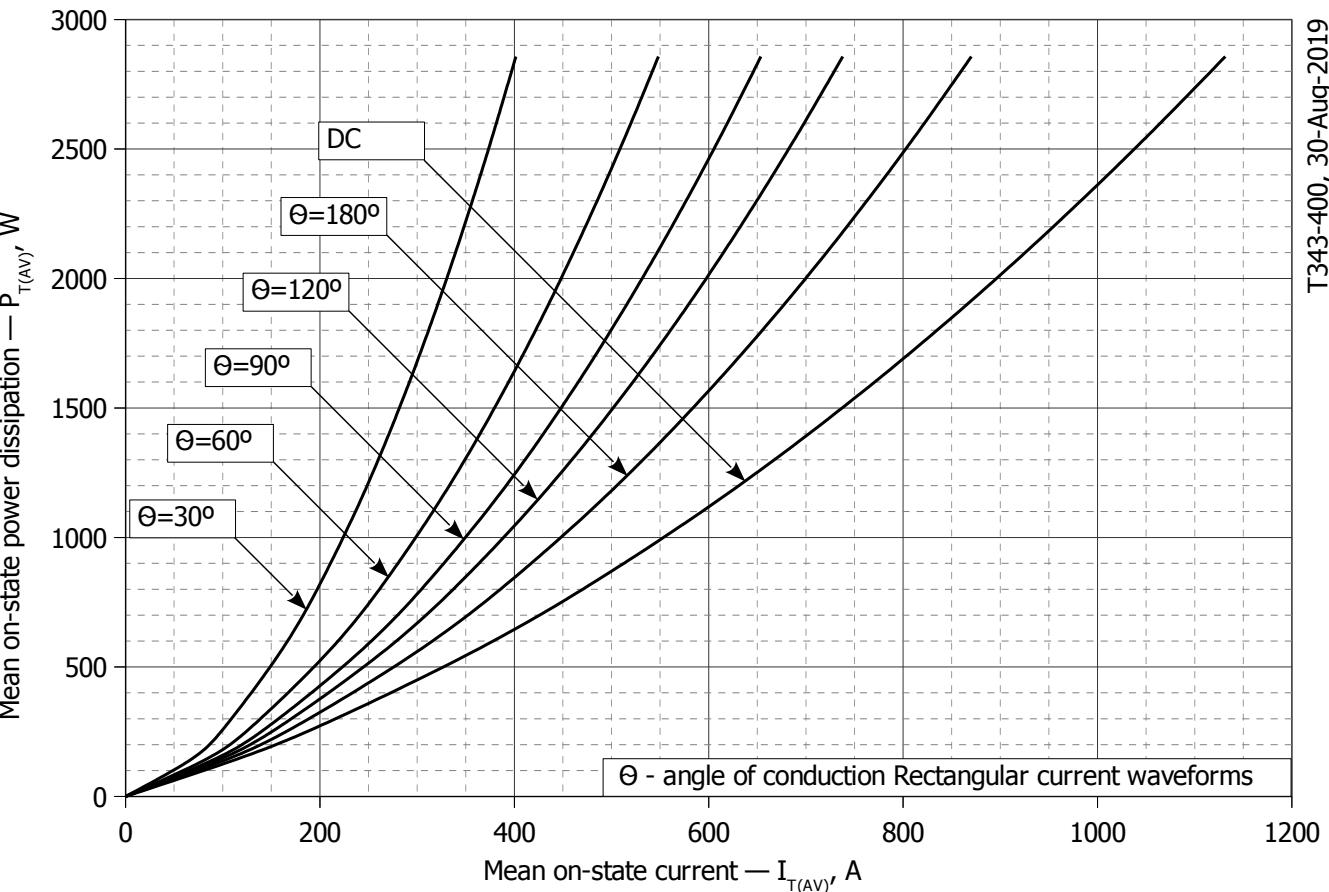


**Fig 4 – Maximum recovered charge  $Q_{rr}$  vs. commutation rate  $di_R/dt$  (25% chord)**

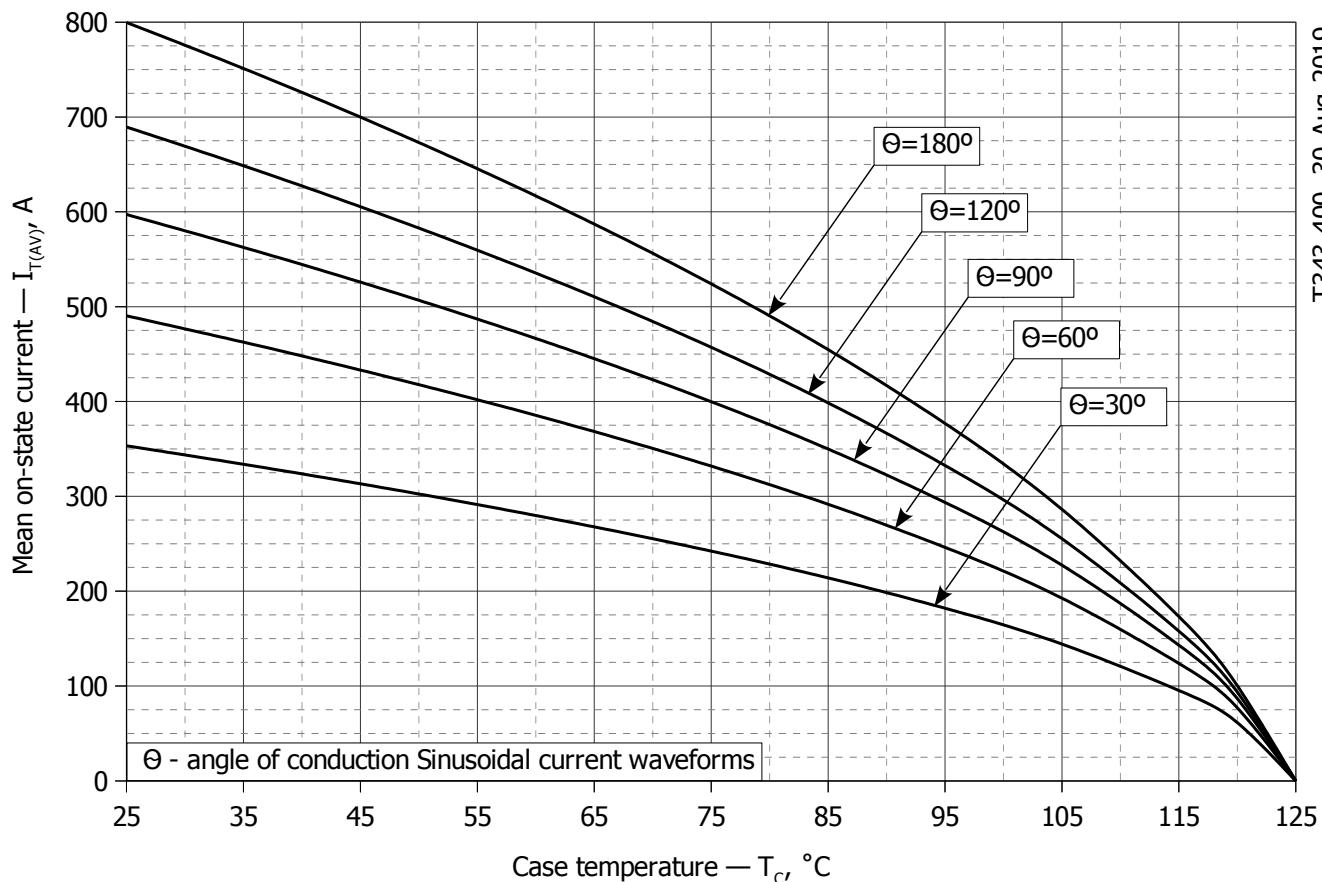




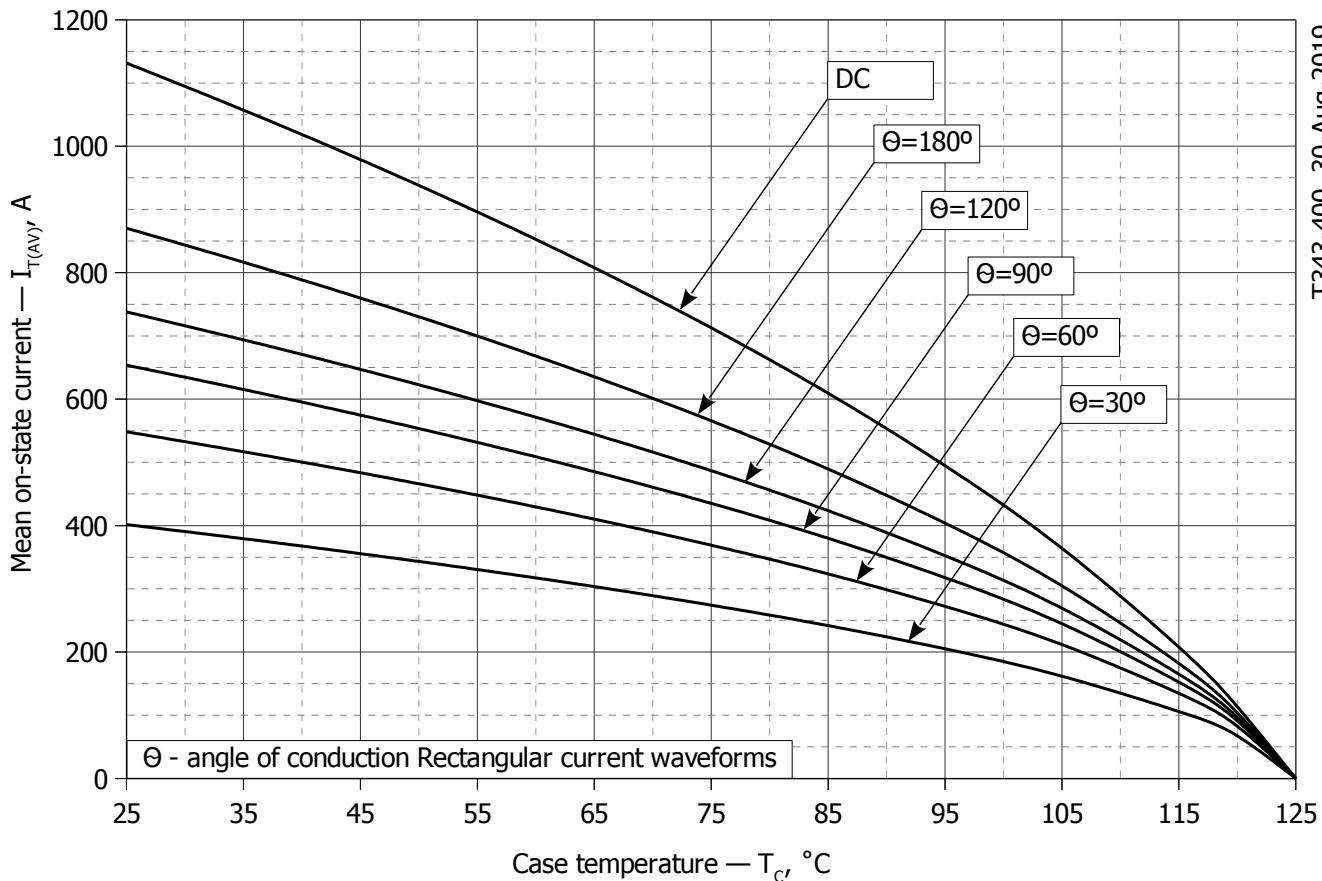
**Fig. 7 - Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for sinusoidal current waveforms at different conduction angles ( $f=50\text{Hz}$ , DSC)**



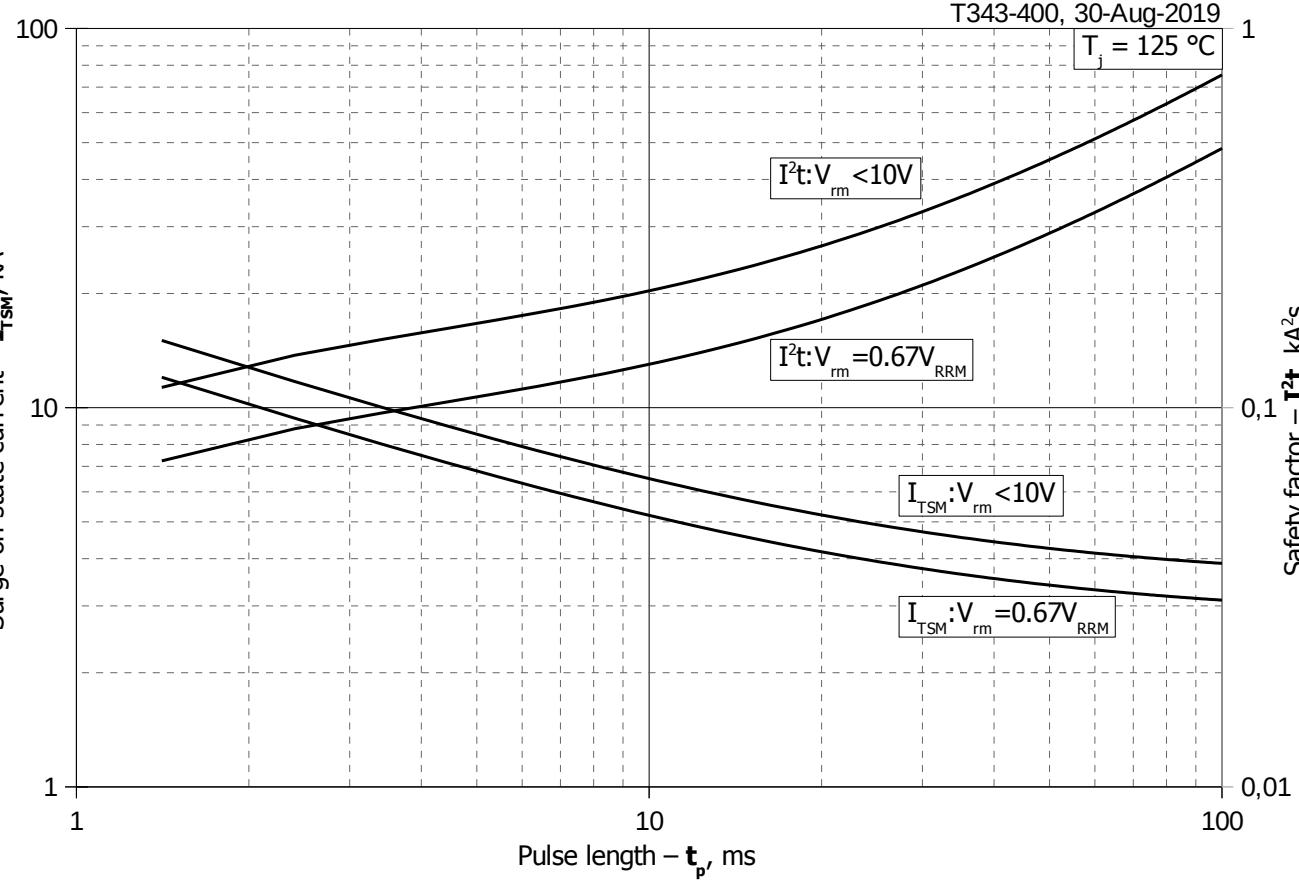
**Fig. 8 – Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for rectangular current waveforms at different conduction angles and for DC ( $f=50\text{Hz}$ , DSC)**



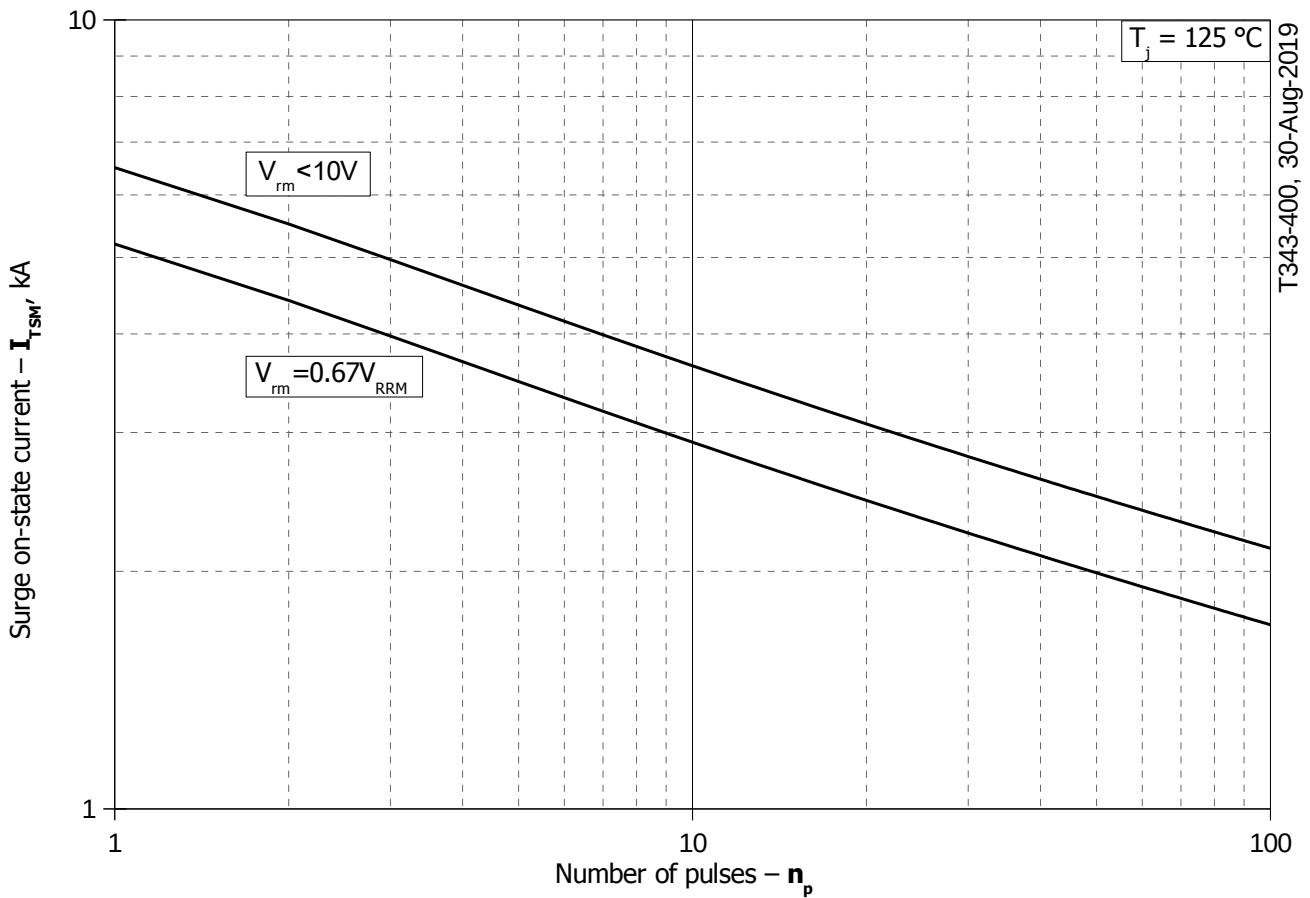
**Fig. 9 – Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for sinusoidal current waveforms at different conduction angles (f=50Hz, DSC)**



**Fig. 10 - Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for rectangular current waveforms at different conduction angles and for DC (f=50Hz, DSC)**



**Fig. 11 – Maximum surge on-state current  $I_{TSM}$  and safety factor  $I^2t$  vs. pulse length  $t_p$**



**Fig. 12 - Maximum surge on-state current  $I_{TSM}$  vs. number of pulses  $n_p$**